



DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.880	0.930	0.980	.035	.037	.039
A1	0.250	0.280	0.310	.010	.011	.012
A2	0.630	0.650	0.670	.025	.026	.027
b	0.340	0.370	0.400	.013	.015	.016
D	2.610	2.660	2.710	.103	.105	.107
D1	2.000 BSC			.079 BSC		
E	2.880	2.930	2.980	.113	.115	.117
E1	2.295 BSC			.090 BSC		
e	0.500 BSC			.020 BSC		
MD	-	-	5 BALLS	-	-	5 BALLS
ME	-	-	5 BALLS	-	-	5 BALLS
N	25 BALLS			25 BALLS		

**NOTES:**

- ALL DIMENSIONS ARE IN MILLIMETERS.
- MD IS THE BALL MATRIX SIZE IN THE "D" DIRECTION, ME IS THE BALL MATRIX SIZE IN THE "E" DIRECTION, AND N IS THE TOTAL NUMBER OF BALLS FOR THE MATRIX SIZE MD X ME AND DOES NOT INCLUDE BALLS FROM ANY DEPOPULATED LOCATIONS.
- DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M.-1994.
- PRIMARY DATUM C (SEATING PLANE) IS DEFINED BY THE CROWNS OF THE SOLDER BALLS.
- DIMENSION b IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER IN A PLANE PARALLEL TO DATUM C.
- THERE SHALL BE A MINIMUM CLEARANCE OF 0.10MM BETWEEN THE EDGE OF THE BUMP AND THE BODY EDGE.
- MARKING SHOWN IS FOR PKG. ORIENTATION PURPOSE ONLY.
- MATERIAL MUST COMPLY WITH BANNED AND RESTRICTED SUBSTANCES SPEC #10-0131.
- ALL DIMENSIONS APPLY TO BOTH LEADED(-) AND PbfREE (+) PKG. CODES.



TITLE:  
PACKAGE OUTLINE, 25 BALLS  
WLCSP , 0.50mm PITCH, C252C2+1

APPROVAL	DOCUMENT CONTROL NO. 21-0924	REV. A	1/1
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-DRAWING NOT TO SCALE-